

Product datasheet

Specifications



controller M200 16 IO transistor SINK

TM200C16U

Main

Range of product	Easy Modicon M200
Product or component type	Logic controller
[Us] rated supply voltage	24 V DC
Discrete I/O number	16
Discrete input number	I8: 1 regular input I2...I5: 4 fast input I0, I1, I6, I7: 4 high speed input
Discrete output number	Q2...Q6: 5 transistor output Q0...Q1: 2 fast output (PLS/PWM/PTO mode)
Discrete input voltage	24 V
Discrete input voltage type	DC
Discrete input current	7 mA for input
Discrete input logic	Sink or source (positive/negative) type 1 conforming to IEC 61131-2
Discrete output voltage	24 V DC
Discrete output current	0.5 A
Discrete output type	Transistor
Discrete output logic	Negative logic (sink)
Power consumption in W	10 W at 24 V DC (with max I/O)

Complementary

Maximum number of I/O expansion module	4 with 135 discrete output(s) for transistor output 4 with 64 discrete output(s) for relay output
Supply voltage limits	20.4...28.8 V
Inrush current	35 A
Voltage state 1 guaranteed	≥ 15 V for input
Voltage state 0 guaranteed	≤ 5 V for input
Input impedance	3.3 kOhm for discrete input
Response time	1 ms turn-on, Q0...Q6 terminal(s) for output 1 ms turn-off, Q0...Q6 terminal(s) for output 5 μ s turn-off, I0, I1, I6, I7 terminal(s) for high speed input 5 μ s turn-on, I0, I1, I6, I7 terminal(s) for high speed input 100 μ s turn-off, I2...I5 terminal(s) for fast input 35 μ s turn-on, I2...I5 terminal(s) for fast input 100 μ s turn-off, I8 terminal(s) for regular input 35 μ s turn-on, I8 terminal(s) for regular input
Configurable filtering time	0 ms for input 3 ms for input 12 ms for input

Maximum current per output common	3.5 A at COM 0
Output frequency	100 kHz for fast output (PWM/PLS mode) at Q0...Q1
Maximum leakage current	0.1 mA for transistor output
Maximum voltage drop	<1 V
Maximum tungsten load	<12 W for output and fast output
Protection type	Overload and short-circuit protection at 3.8 A
Reset time	1 s automatic reset
Memory capacity	512 byte internal flash for backup of programs
Data storage equipment	32 GB micro SD card (optional)
Battery type	BR2032 Li-CFx (Lithium-Carbon Monofluoride), battery life: 5 year(s)
Backup time	3 years at 25 °C (by interruption of power supply)
Execution time for 1 KInstruction	0.3 ms for event and periodic task
Execution time per instruction	0.2 µs Boolean
Extc time for event task	60 µs response time
Clock drift	<= 90 s/month at 25 °C
Regulation loop	Adjustable PID regulator up to 14 simultaneous loops
Positioning functions	PWM/PLS 2 channel(s) at 100 kHz
Control signal type	Quadrature (x1, x2, x4) at 100 kHz for fast input (HSC mode) Pulse/direction at 100 kHz for fast input (HSC mode) Single phase at 100 kHz for fast input (HSC mode) CW/CCW at 100 kHz for fast input (HSC mode)
Counting input number	4 fast input (HSC mode) at 100 kHz 32 bits
Integrated connection type	USB port with mini B USB 2.0 connector Non isolated serial link serial 1 with terminal block connector and RS485 interface Non isolated serial link serial 2 with terminal block connector and RS232/RS485 interface Isolated serial link serial 2 with terminal block connector and RS485 interface
Transmission rate	1.2...115.2 kbit/s (115.2 kbit/s by default) for bus length of 15 m for RS485 1.2...115.2 kbit/s (115.2 kbit/s by default) for bus length of 3 m for RS232 12 Mbit/s for USB
Communication port protocol	USB port: USB - SoMachine-Network Non isolated serial link: Modbus master/slave - RTU/ASCII or SoMachine-Network
Local signalling	1 LED (green) for PWR 1 LED (green) for RUN 1 LED (red) for module error (ERR) 1 LED (green) for SD card access (SD) 1 LED (red) for BAT 1 LED (green) for SL1 1 LED per channel (green) for I/O state
Electrical connection	Mini B USB 2.0 connector for a programming terminal removable screw terminal block for inputs removable screw terminal block for outputs removable screw terminal block, 3 terminal(s) for connecting the 24 V DC power supply removable screw terminal block, 4 terminal(s) for connecting the serial link 1
Maximum cable distance between devices	Unshielded cable: <50 m for input Shielded cable: <10 m for fast input Shielded cable: <10 m for high speed input Unshielded cable: <150 m for output

Insulation	<p>Non-insulated between inputs</p> <p>Between input and internal logic at 500 V AC</p> <p>Between fast input and internal logic at 500 V AC</p> <p>Between input groups at 500 V AC</p> <p>Between output and internal logic at 500 V AC</p> <p>Between output groups at 500 V AC</p> <p>Between supply and internal logic at 500 V DC</p>
Marking	CE
Mounting support	<p>Top hat type TH35-15 rail conforming to IEC 60715</p> <p>Top hat type TH35-7.5 plate or panel with fixing kit conforming to IEC 60715</p>
Height	90 mm
Depth	70 mm
Width	110 mm
Net weight	0.339 kg

Environment

IP degree of protection	IP20 with protective cover in place
Product certifications	CE
Standards	<p>IEC 61010-2-201</p> <p>IEC 61131-2</p>
Electromagnetic compatibility	<p>Electrostatic discharge immunity test - test level: 8 kV (air discharge) conforming to IEC 61000-4-2</p> <p>Electrostatic discharge immunity test - test level: 6 kV (contact discharge) conforming to IEC 61000-4-2</p> <p>Susceptibility to electromagnetic fields - test level: 10 V/m (80 MHz...3 GHz) conforming to IEC 61000-4-3</p> <p>Magnetic field at power frequency - test level: 30 A/m conforming to IEC 61000-4-8</p> <p>Electrical fast transient/burst immunity test - test level: 2 kV (power lines) conforming to IEC 61000-4-4</p> <p>Electrical fast transient/burst immunity test - test level: 2 kV (relay output) conforming to IEC 61000-4-4</p> <p>Electrical fast transient/burst immunity test - test level: 1 kV (I/O) conforming to IEC 61000-4-4</p> <p>Electrical fast transient/burst immunity test - test level: 1 kV (serial link) conforming to IEC 61000-4-4</p> <p>1.2/50 µs shock waves immunity test - test level: 1 kV (power lines (DC)) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 2 kV (power lines (AC)) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 2 kV (relay output) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 1 kV (I/O) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 1 kV (shielded cable) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 0.5 kV (power lines (DC)) conforming to IEC 61000-4-5</p> <p>1.2/50 µs shock waves immunity test - test level: 1 kV (power lines (AC)) conforming to IEC 61000-4-5</p> <p>Conducted RF disturbances - test level: 10 V (0.15...80 MHz) conforming to IEC 61000-4-6</p> <p>Conducted emission - test level: 79 dBµV/m QP/66 dBµV/m AV (power lines (AC)) conforming to IEC 55011</p> <p>Conducted emission - test level: 73 dBµV/m QP/60 dBµV/m AV (power lines (AC)) conforming to IEC 55011</p> <p>Radiated emission - test level: 40 dBµV/m QP class A (10 m) conforming to IEC 55011</p> <p>Radiated emission - test level: 47 dBµV/m QP class A (10 m) conforming to IEC 55011</p>
Shock resistance	<p>15 gn for 11 ms</p> <p>30 gn for 6 ms</p>
Immunity to microbreaks	2 ms

Vibration resistance	3.5 mm at 5...8.4 Hz on symmetrical rail 1 gn at 8.4...150 Hz on symmetrical rail 3.5 mm at 5...8.7 Hz on panel mounting 2 gn at 8.7...150 Hz on panel mounting
Relative humidity	10...95 %, without condensation (in operation) 10...95 %, without condensation (in storage)
Ambient air temperature for operation	0...55 °C (horizontal installation)
Ambient air temperature for storage	-25...70 °C
Pollution degree	<= 2
Operating altitude	0...2000 m
Storage altitude	0...3000 m

Packing Units

Unit Type of Package 1	PCE
Number of Units in Package 1	1
Package 1 Height	13.6 cm
Package 1 Width	9 cm
Package 1 Length	11.8 cm
Package 1 Weight	512.5 g
Unit Type of Package 2	S03
Number of Units in Package 2	18
Package 2 Height	30 cm
Package 2 Width	30 cm
Package 2 Length	40 cm
Package 2 Weight	9756 g
Unit Type of Package 3	P12
Number of Units in Package 3	288
Package 3 Height	80 cm
Package 3 Width	120 cm
Package 3 Length	110 cm
Package 3 Weight	243144 g

Contractual warranty

Warranty (in months)	18
-----------------------------	----



Environmental Data

Schneider Electric aims to achieve Net Zero status by 2050 through supply chain partnerships, lower impact materials, and circularity via our ongoing “Use Better, Use Longer, Use Again” campaign to extend product lifetimes and recyclability.

[Environmental Data explained >](#)

[How we assess product sustainability >](#)



Environmental footprint

Total lifecycle Carbon footprint	775 kg CO2 eq.
Carbon footprint of the manufacturing phase [A1 to A3]	10 kg CO2 eq.
Carbon footprint of the distribution phase [A4]	0.1 kg CO2 eq.
Carbon footprint of the installation phase [A5]	0.2 kg CO2 eq.
Carbon footprint of the use phase [B2, B3, B4, B6]	765 kg CO2 eq.
Carbon footprint of the end-of-life phase [C1 to C4]	0.2 kg CO2 eq.
Environmental Disclosure	Product Environmental Profile

Use Better



Materials and Substances

Packaging made with recycled cardboard	Yes
Packaging without single use plastic	Yes
EU RoHS Directive	Compliant By Exemption
REACH Regulation	Reference contains Substances of Very High Concern above the threshold

Use Longer



Lifetime extension

Repair	No
--------	----

Use Again



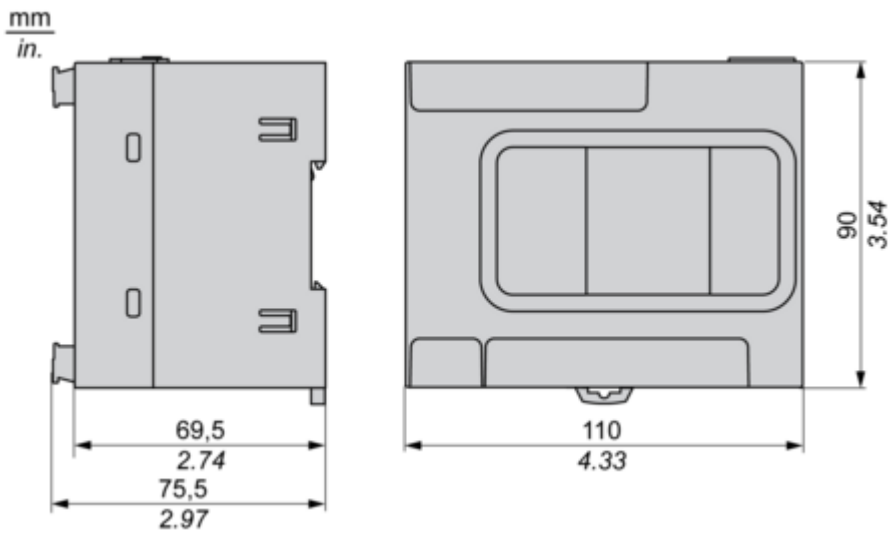
Repack and remanufacture

End of life manual availability	End of Life Information
Take-back	Nej

Dimensions Drawings

Dimensions Drawings

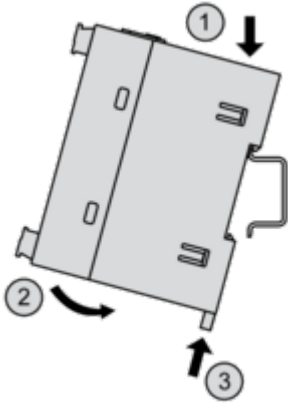
Dimensions



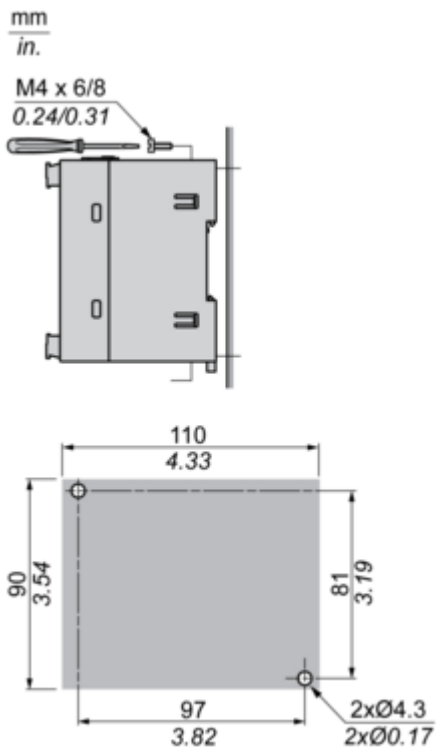
Mounting and Clearance

Mounting and Clearance

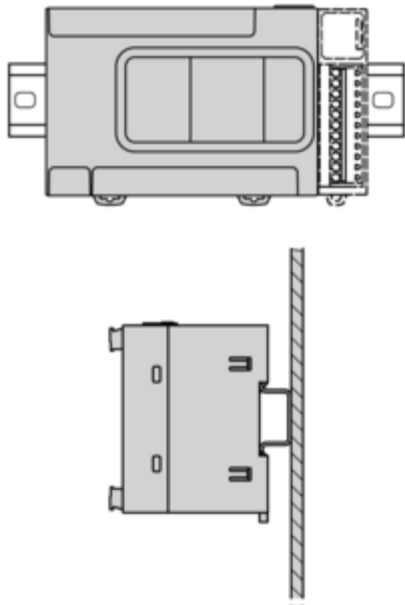
Mounting on a Rail

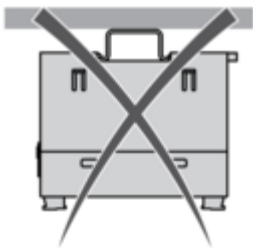
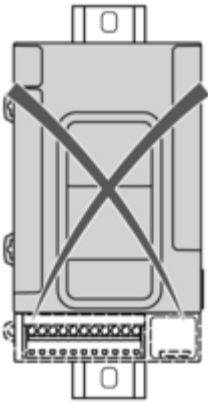


Direct Mounting on a Panel Surface



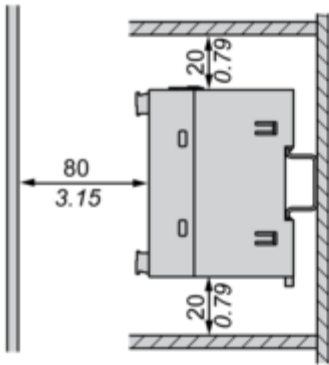
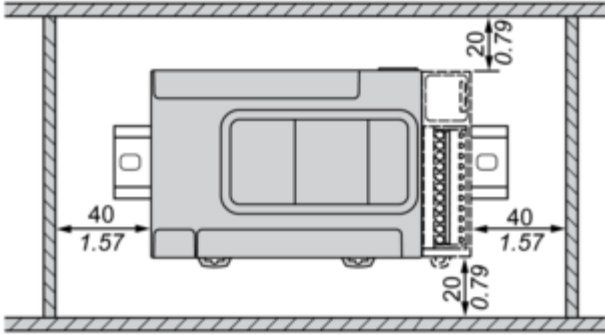
Mounting Position



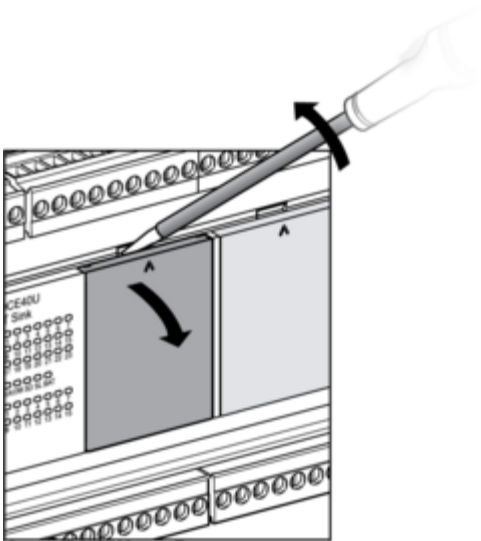


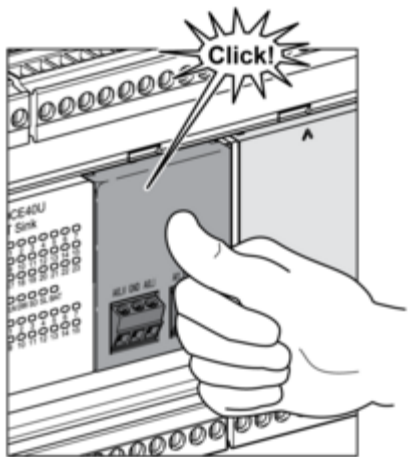
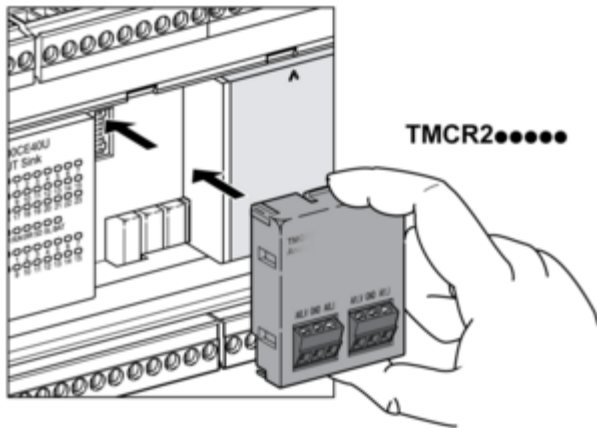
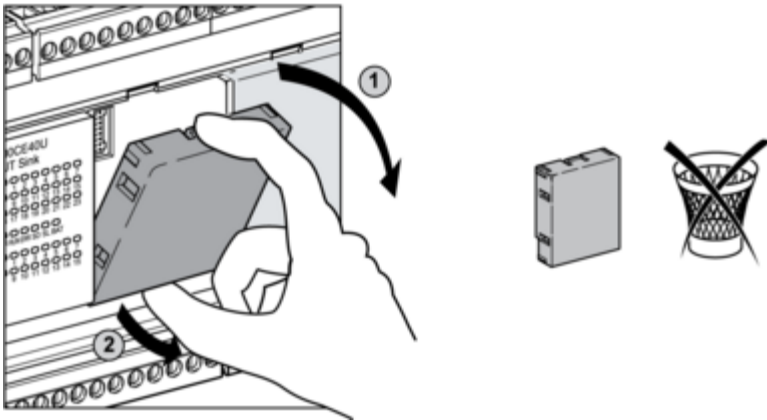
Clearance

mm
in.

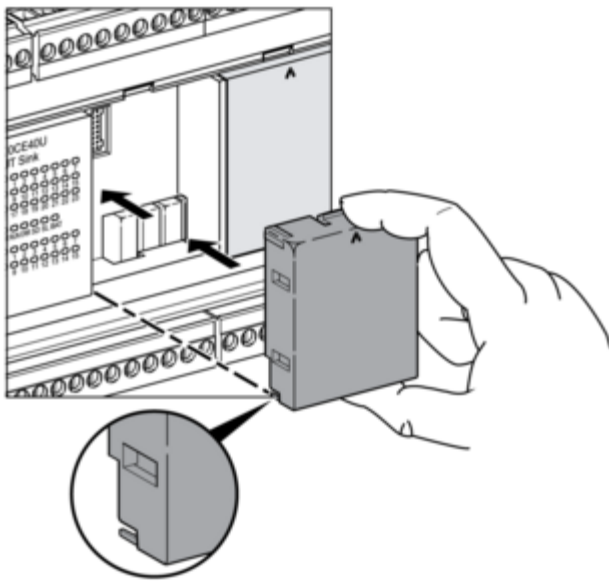
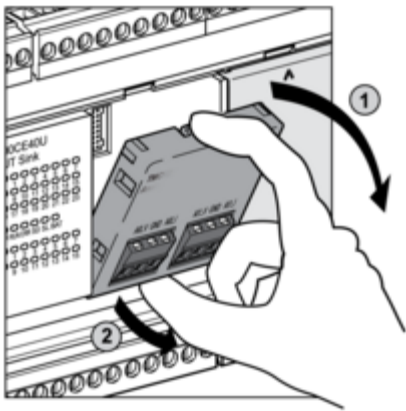
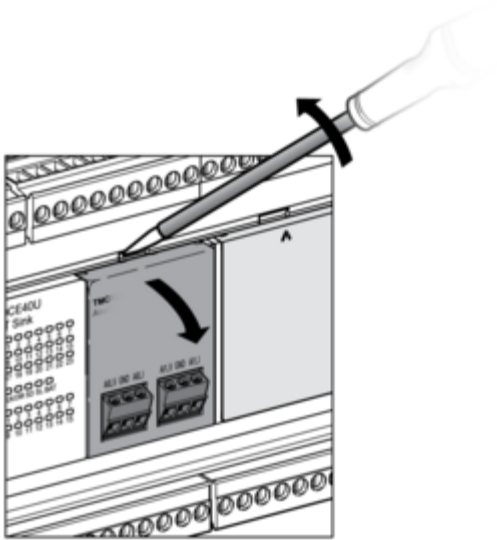


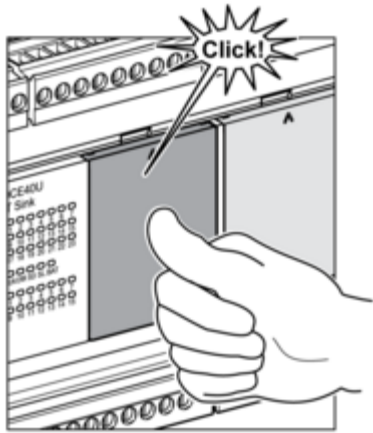
TMCR2•••Installation





TMCR2... De-Installation

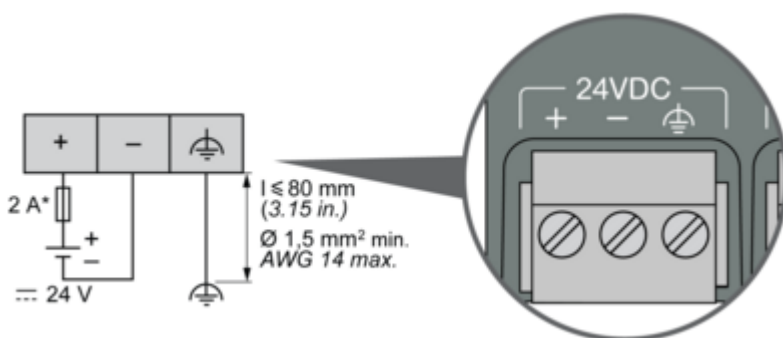
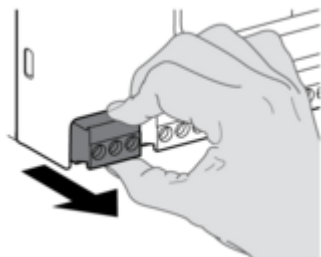




Connections and Schema

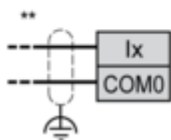
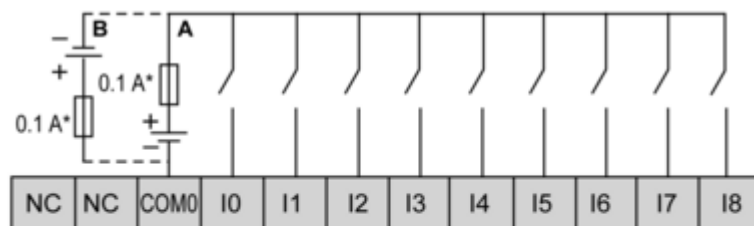
Wiring Diagram / Connections Schema

DC Power Supply



(*) Type T fuse

Digital Inputs (Sink or Source)



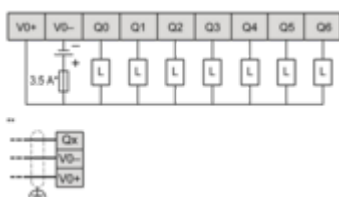
(*) Type T fuse

A : Sink wiring (positive logic)

B : Source wiring (negative logic)

(**) Fast inputs

Regular and Fast Transistor Output



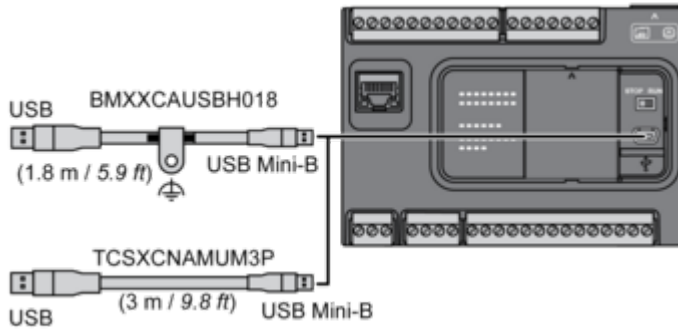
(*) Type T fuse

(**) Fast inputs

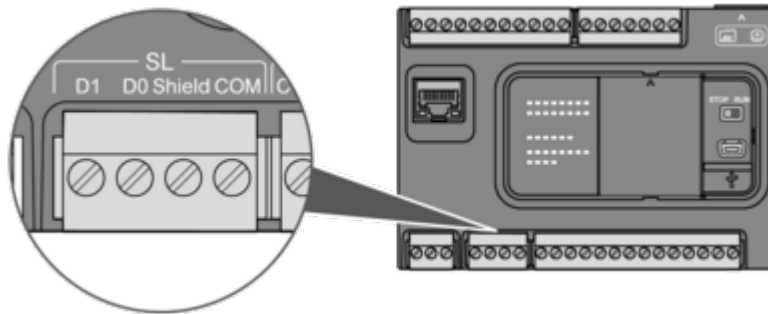
(1) The V0+ and V1+ terminals are not connected internally.

(2) The V0- and V1- terminals are not connected internally.

USB Mini-B Connection



SL1 Connection



D1 : D1 (A+)

D0 : D0 (B-)

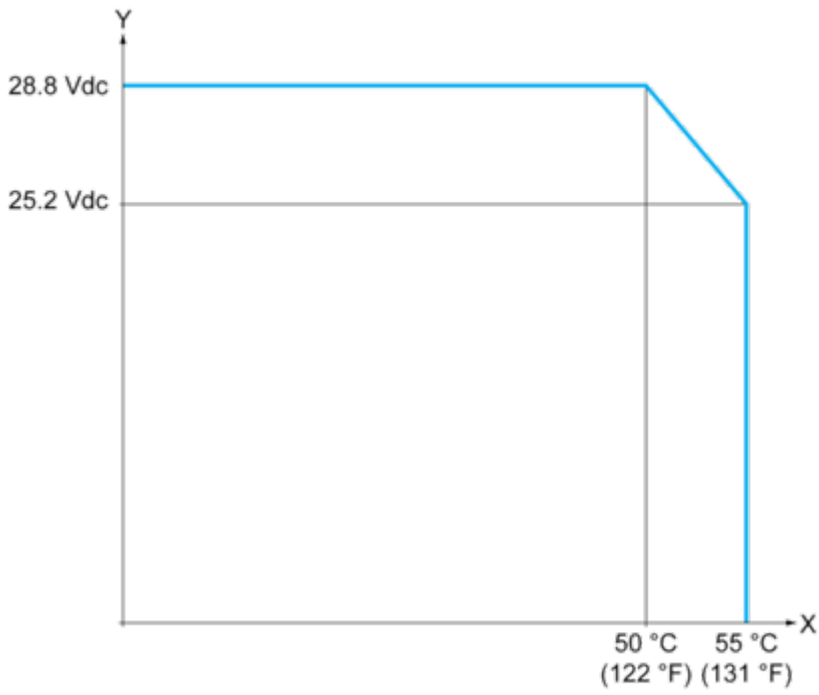
Shield : Shield

COM : 0 V Com

Performance Curves

Derating Curves

Digital Inputs



X : Ambient temperature (°C / °F)
Y : Input voltage (V)